



VMDSEMI

**VUPA002R070PA**

**Datasheet**



VMDSEMI

## General Description

## Symbol

$V_{(BR)DSS}$	$R_{DS(ON)_{max}}$	$I_D$
-20V	7.0mΩ@-4.5V	-45A
	9.0mΩ@-2.5V	

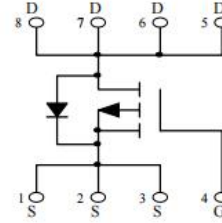


Figure 1 Symbol of VUPA002R070PA

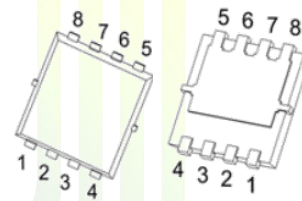
## Features

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance

## Application

- Battery protection applications
- Load switch

## Package Type



**PDFN3.3X3.3-8L**

Figure 2 Package Type of VUPA002R070PA

## Ordering Information

Product Name	Package
VUPA002R070PA	PDFN3.3X3.3-8L

**Absolute Maximum Ratings** ( $T_A = 25\text{ °C}$ , unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DSS}$	-20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 12$	V
Continuous Drain Current <sup>Note1</sup>	$I_D$	-45	A
Pulsed Drain Current <sup>Note2</sup>	$I_{DM}$	-180	
Total Power Dissipation <sup>Note4</sup>	$P_D$	83	W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C

**Thermal Resistance**

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note5</sup>	$R_{\theta JA}$		55		°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$		1.5		°C/W

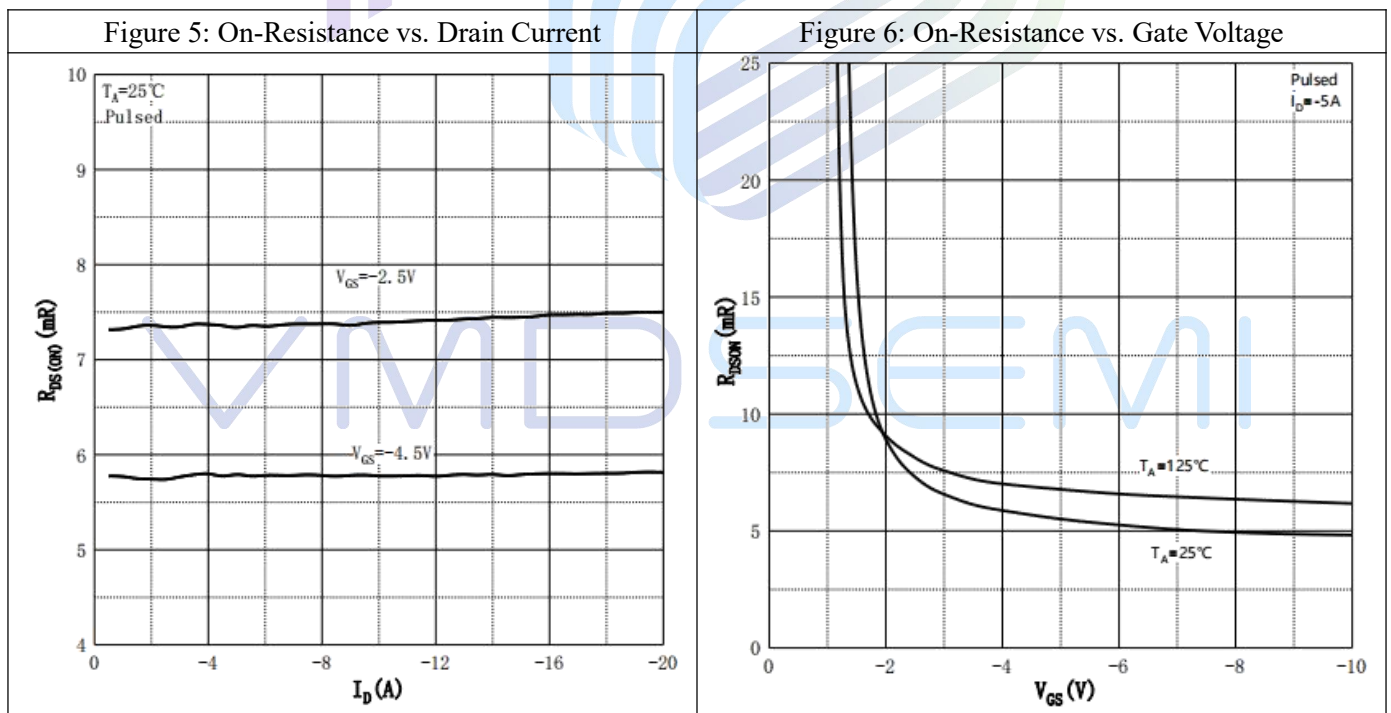
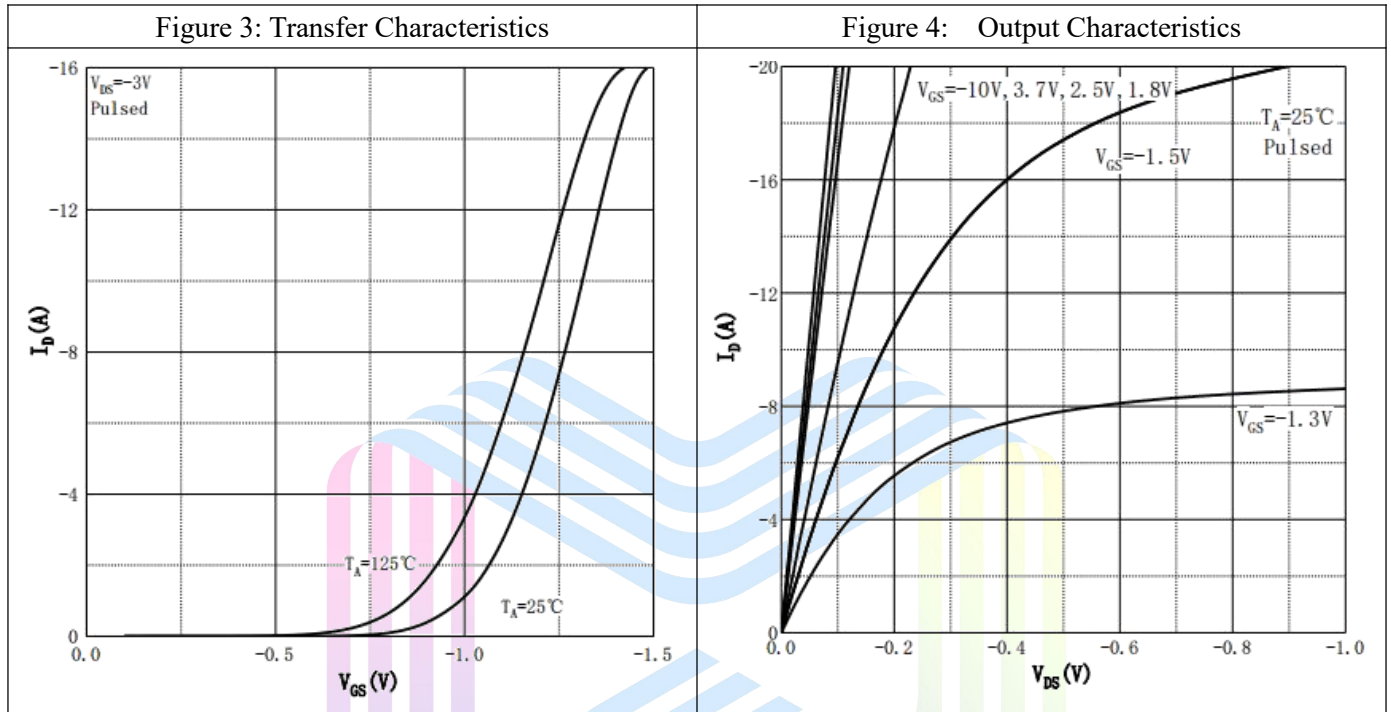
**Electrical Characteristics** ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

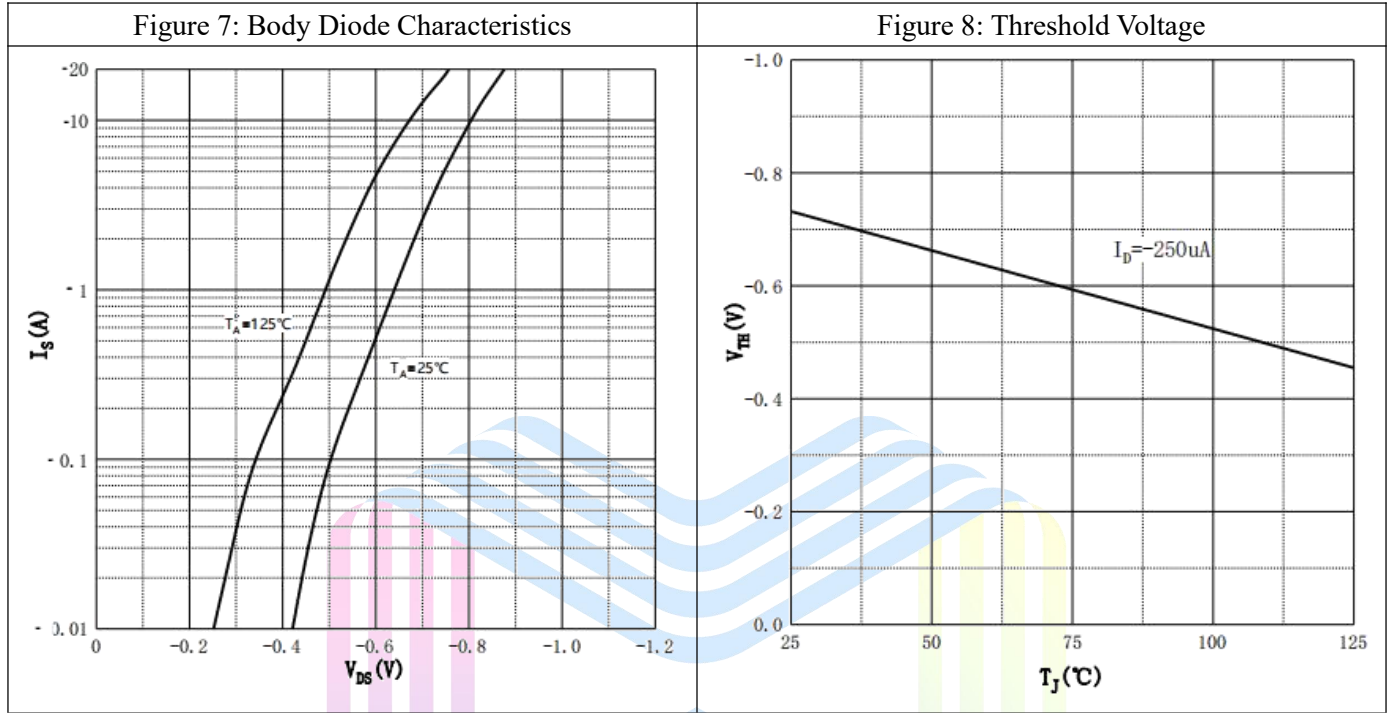
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Statistic Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	-20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-16V, V_{GS}=0V$			-1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 12V, V_{DS}=0V$			$\pm 100$	nA
Gate Threshold Voltage <sup>Note3</sup>	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.4	-0.75	-1.0	V
Static Drain-Source On-Resistance <sup>Note3</sup>	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-20A$		5.8	7	mΩ
		$V_{GS}=-2.5V, I_D=-20A$		7.5	9	
Forward Transconductance <sup>Note3</sup>	$g_{FS}$	$V_{DS}=-5V, I_D=-20A$	50			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{ISS}$	$V_{DS}=-10V$		3600		pF
Output Capacitance	$C_{OSS}$	$V_{GS}=0V$		560		pF
Reverse Transfer Capacitance	$C_{RSS}$	$f=1MHz$		440		pF
Total Gate Charge	$Q_g$	$V_{DS}=-10V$		50		nC
Gate-Source Charge	$Q_{gs}$	$V_{GS}=-4.5V$		9		
Gate-Drain Charge	$Q_{gd}$	$I_D=-20A$		14		
Gate Resistance	$R_g$	$f=1MHz, \text{Open drain}$		3		Ω
<b>Switching Parameters</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=-10V$		16		ns
Turn-on Rise Time	$t_r$	$V_{GS}=-4.5V$		40		
Turn-off Delay Time	$t_{d(off)}$	$R_L=3\Omega$		83		
Turn-off Fall Time	$t_f$	$R_G=0.5\Omega$		22		
<b>Diode Characteristics</b>						
Diode Forward Voltage <sup>Note3</sup>	$V_{DS}$	$V_{GS}=0V, I_S=-20A$			-1.2	V

Notes :

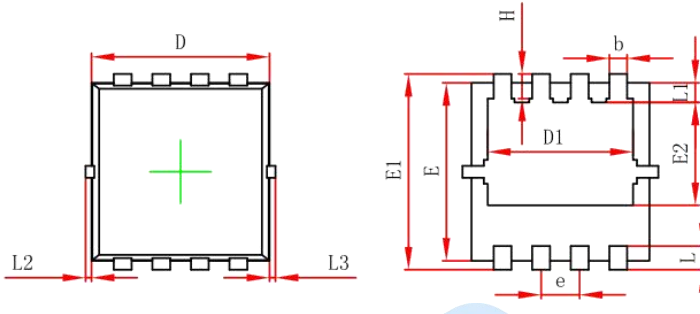
- 1.The maximum current rating is limited by package.And device mounted on a large heatsink.
- 2.Pulse Test : Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150^\circ\text{C}$ .And device mounted on a large heatsink
- 5.Device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

## Typical Performance Characteristics





VMDSEMI

**Mechanical Dimensions:**
**PDFN3.3X3.3-8L Package Information**

 Top View  
 [顶视图]

 Bottom View  
 [背视图]

 Side View  
 [侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.		0.006 REF.	
A2	0-0.05		0-0.002	
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0-0.100		0-0.004	
L3	0-0.100		0-0.004	
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°



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